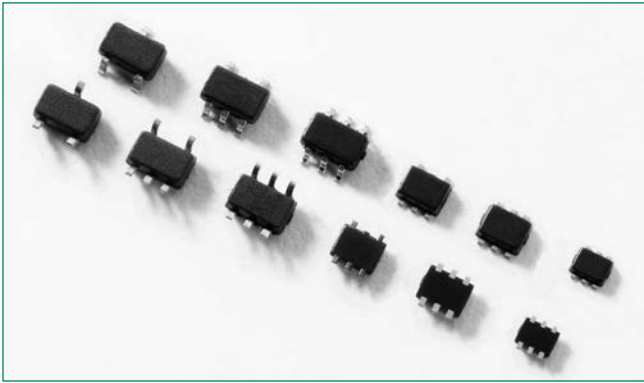


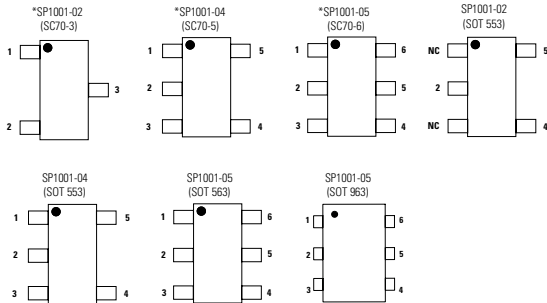
**SP1001 Series - 8pF 15kV Unidirectional TVS Array**



**Description**

Avalanche breakdown diodes fabricated in a proprietary silicon avalanche technology protect each I/O pin to provide a high level of protection for electronic equipment that may experience destructive electrostatic discharges (ESD). These robust diodes can safely absorb repetitive ESD strikes above the maximum level specified in IEC 61000-4-2 international standard (Level 4, ±8kV contact discharge) without performance degradation. Their very low loading capacitance also makes them ideal for protecting high-speed signal pins.

**Pinout**

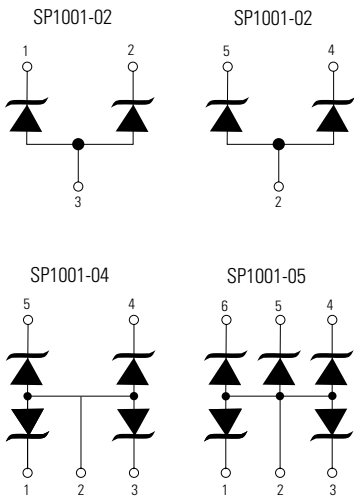


Note: \* AEC-Q101 Qualified

**Features**

- Low capacitance of 8pF (TYP) per I/O
- ESD protection of ±15kV contact discharge, ±30kV air discharge, (Level 4, IEC 61000-4-2)
- EFT protection, IEC 61000-4-4, 40A (5/50ns)
- Low leakage current of 0.5µA (MAX) at 5V
- Small package saves board space
- Lightning Protection, IEC 61000-4-5, 2A (8/20µs)
- AEC-Q101 Qualified

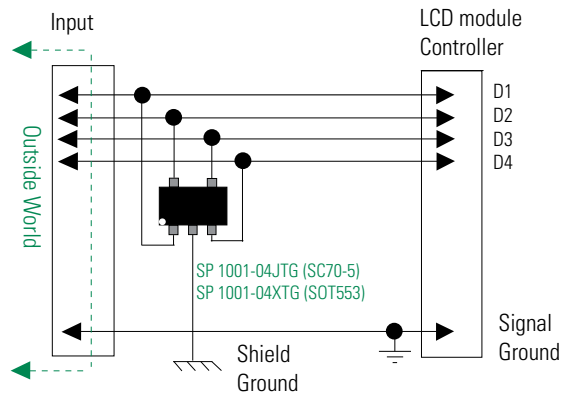
**Functional Block Diagram**



**Applications**

- Computer Peripherals
- Mobile Phones
- Digital Cameras
- Desktops/Notebooks
- LCD/PDPTVs
- Set Top Boxes
- DVD Players
- MP3/PMP

**Application Example**



Life Support Note:

**Not Intended for Use in Life Support or Life Saving Applications**

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

### Absolute Maximum Ratings

Symbol	Parameter	Value	Units
$I_{PP}$	Peak Current ( $t_p=8/20\mu s$ )	2	A
$T_{OP}$	Operating Temperature	-40 to 125	°C
$T_{STOR}$	Storage Temperature	-505 to 150	°C

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### Thermal Information

Parameter	Rating	Units
Storage Temperature Range	-55 to 150	°C
Maximum Junction Temperature	150	°C
Maximum Lead Temperature (Soldering 20-40s)	260	°C
Thermal resistance junction to ambient	124.21	°C/W
Thermal resistance junction to case	190.54	°C/W
Power dissipation	1	W

### Electrical Characteristics ( $T_{OP} = 25^\circ C$ )

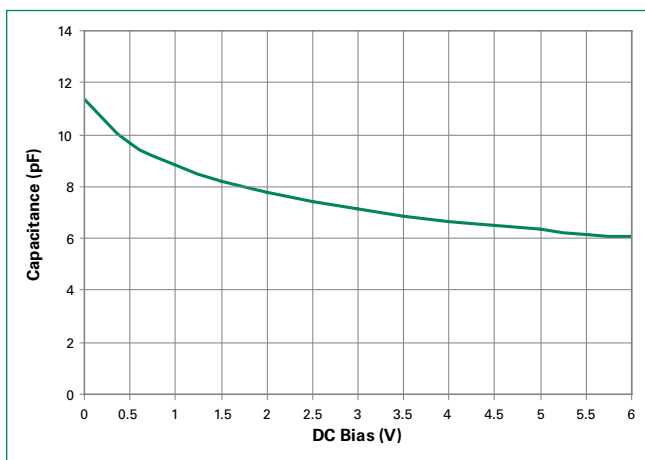
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Forward Voltage Drop	$V_F$	$I_F=10mA$	0.7	0.9	1.2	V
Reverse Voltage Drop	$V_R$	$I_R=1mA$	7.0	7.8	8.5	V
Reverse Standoff Voltage	$V_{RVM}$	$I_R \leq 1\mu A$			5.5	V
Reverse Leakage Current	$I_{LEAK}$	$V_R=5V$			0.1	$\mu A$
Clamp Voltage <sup>1</sup>	$V_C$	$I_{PP}=1A, t_p=8/20\mu s, Fwd$		8.0	11.0	V
		$I_{PP}=2A, t_p=8/20\mu s, Fwd$		9.7	13.0	V
Dynamic Resistance	$R_{DYN}$	$(V_{C2} - V_{C1}) / (I_{PP2} - I_{PP1})$		1.7		$\Omega$
ESD Withstand Voltage <sup>1,2</sup>	$V_{ESD}$	IEC 61000-4-2 (Contact)	$\pm 15$			kV
		IEC 61000-4-2 (Air)	$\pm 30$			kV
Diode Capacitance <sup>1</sup>	$C_D$	Reverse Bias=0V		12		pF
		Reverse Bias=2.5V		8		pF
		Reverse Bias=5V		7		pF

**Notes:**

<sup>1</sup> Parameter is guaranteed by component characterization

<sup>2</sup> A minimum of 1,000 ESD pulses are applied at 1s intervals between the anode and common cathode of each diode

### Capacitance vs. Reverse Bias

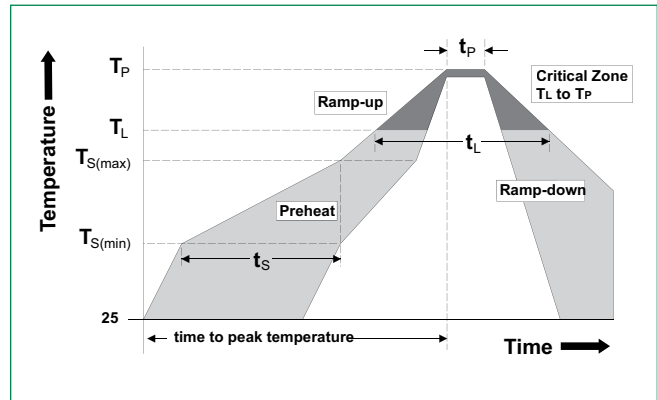


### Design Consideration

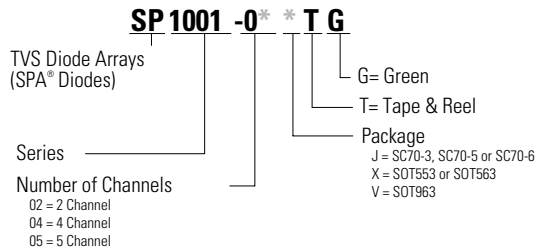
Because of the fast rise-time of the ESD transient, placement of ESD components is a key design consideration. To achieve optimal ESD suppression, the components should be placed on the circuit board as close to the source of the ESD transient as possible. Install the ESD suppressors directly behind the connector so that they are the first board-level circuit component encountered by the ESD transient. They are connected from signal/data line to ground.

### Soldering Parameters

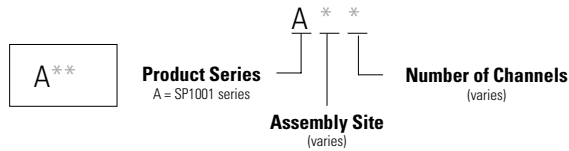
<b>Reflow Condition</b>		Pb – Free assembly
<b>Pre Heat</b>	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
<b>Average ramp up rate (Liquidus) Temp (<math>T_L</math>) to peak</b>		3°C/second max
<b><math>T_{s(max)}</math> to <math>T_L</math> - Ramp-up Rate</b>		3°C/second max
<b>Reflow</b>	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Temperature ( $t_L$ )	60 – 150 seconds
<b>Peak Temperature (<math>T_p</math>)</b>		260 <sup>+0/5</sup> °C
<b>Time within 5°C of actual peak Temperature (<math>t_p</math>)</b>		20 – 40 seconds
<b>Ramp-down Rate</b>		6°C/second max
<b>Time 25°C to peak Temperature (<math>T_p</math>)</b>		8 minutes max.
<b>Do not exceed</b>		260°C



### Part Numbering System



### Part Marking System



### Ordering Information

Part Number	Package	Marking	Min. Order Qty.
SP1001-02JTG	SC70-3	A*2	3000
SP1001-02XTG	SOT553	A*2	3000
SP1001-04JTG	SC70-5	A*4	3000
SP1001-04XTG	SOT553	A*4	3000
SP1001-05JTG	SC70-6	A*5	3000
SP1001-05VTG	SOT963	A5	8000
SP1001-05XTG	SOT563	A*5	3000

### Product Characteristics

<b>Lead Plating</b>	Matte Tin (SC70-x) Pre-Plated Frame (SOT5x3, SOT963)
<b>Lead Material</b>	Copper Alloy
<b>Lead Coplanarity</b>	0.004 inches(0.102mm)
<b>Substrate material</b>	Silicon
<b>Body Material</b>	Molded Compound
<b>Flammability</b>	UL Recognized compound meeting flammability rating V-0

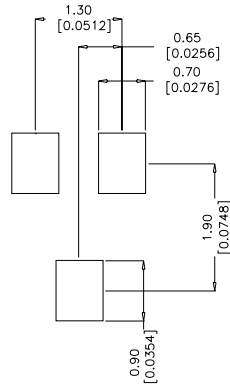
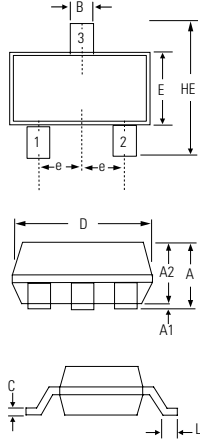
**Notes :**

1. All dimensions are in millimeters
2. Dimensions include solder plating.
3. Dimensions are exclusive of mold flash & metal burr.

**Package Dimensions — SC70**

**SC70-3**

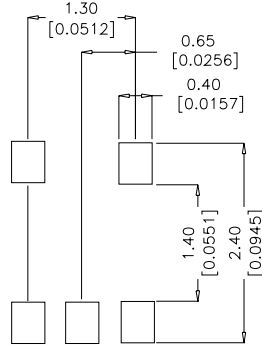
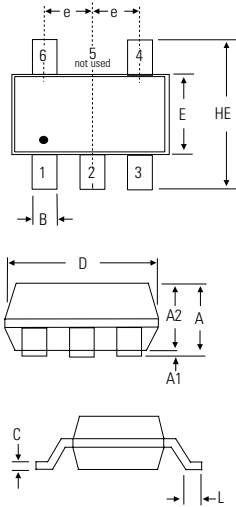
Solder Pad Layout



Package	SC70-3			
Pins	3			
JEDEC	MO-203			
	Millimeters		Inches	
	Min	Max	Min	Max
A	0.80	1.10	0.031	0.043
A1	0.00	0.10	0.000	0.004
A2	0.70	1.00	0.028	0.039
B	0.15	0.30	0.006	0.012
c	0.08	0.25	0.003	0.010
D	1.85	2.25	0.073	0.089
E	1.15	1.35	0.045	0.053
e	0.66 BSC		0.026 BSC	
HE	2.00	2.40	0.079	0.094
L	0.26	0.46	0.010	0.018

**SC70-5**

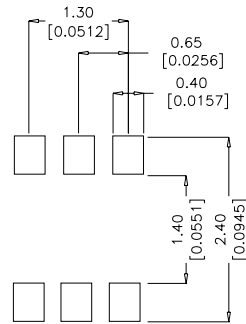
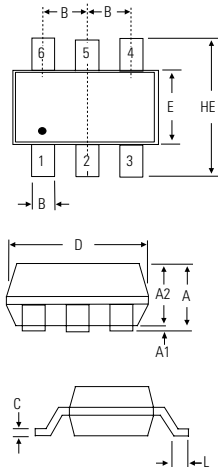
Solder Pad Layout



Package	SC70-5			
Pins	5			
JEDEC	MO-203			
	Millimeters		Inches	
	Min	Max	Min	Max
A	0.80	1.10	0.031	0.043
A1	0.00	0.10	0.000	0.004
A2	0.70	1.00	0.028	0.039
B	0.15	0.30	0.006	0.012
c	0.08	0.25	0.003	0.010
D	1.85	2.25	0.073	0.089
E	1.15	1.35	0.045	0.053
e	0.65 BSC		0.026 BSC	
HE	2.00	2.40	0.079	0.094
L	0.26	0.46	0.010	0.018

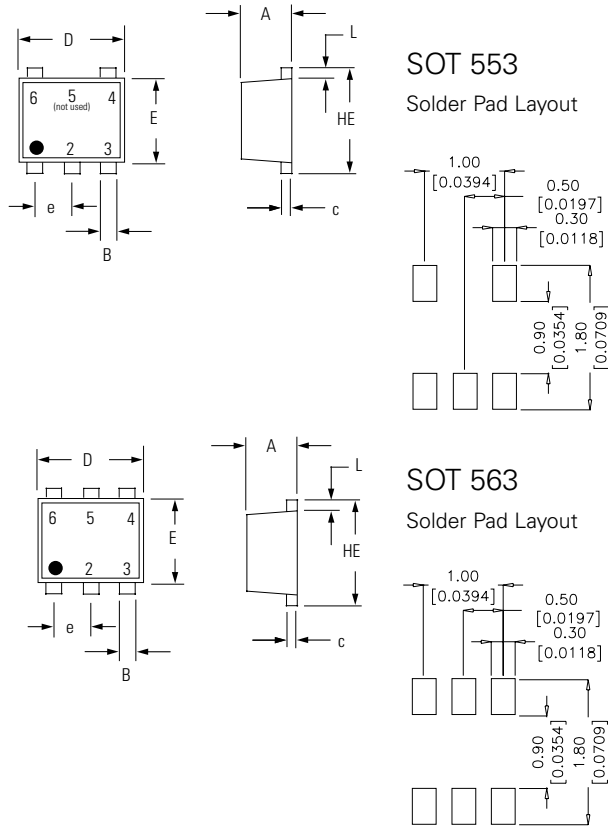
**SC70-6**

Solder Pad Layout



Package	SC70-6			
Pins	6			
JEDEC	MO-203			
	Millimeters		Inches	
	Min	Max	Min	Max
A	0.80	1.10	0.031	0.043
A1	0.00	0.10	0.000	0.004
A2	0.70	1.00	0.028	0.039
B	0.15	0.30	0.006	0.012
c	0.08	0.25	0.003	0.010
D	1.85	2.25	0.073	0.089
E	1.15	1.35	0.045	0.053
e	0.65 BSC		0.026 BSC	
HE	2.00	2.40	0.079	0.094
L	0.26	0.46	0.010	0.018

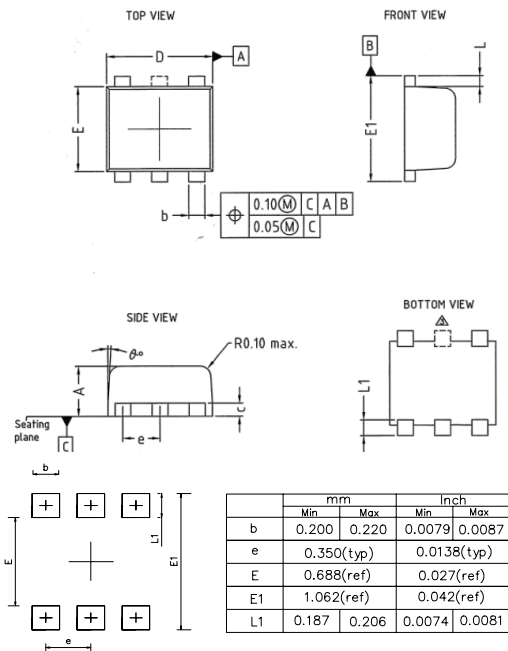
**Package Dimensions – SOT553 and SOT563**



Package	SOT 553			
Pins	5			
	Millimeters		Inches	
	Min	Max	Min	Max
A	0.50	0.60	0.020	0.024
B	0.17	0.27	0.007	0.011
c	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
e	0.50 BSC		0.020 BSC	
L	0.10	0.30	0.004	0.012
HE	1.50	1.70	0.059	0.067

Package	SOT 563			
Pins	6			
	Millimeters		Inches	
	Min	Max	Min	Max
A	0.50	0.60	0.020	0.024
B	0.17	0.27	0.007	0.011
c	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
e	0.50 BSC		0.020 BSC	
L	0.10	0.30	0.004	0.012
HE	1.50	1.70	0.059	0.067

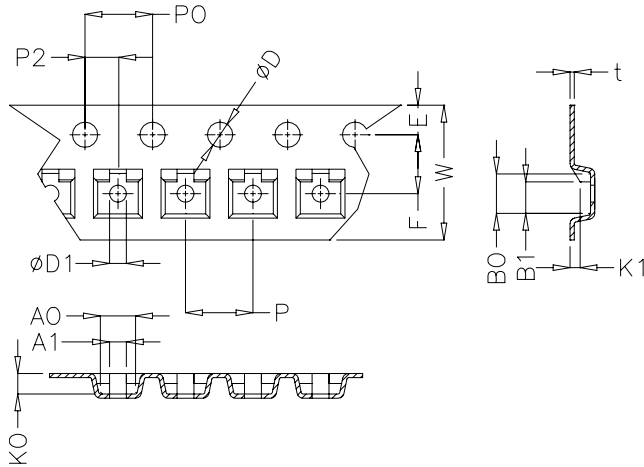
**Package Dimensions – SOT963**



Recommended Solder Pad Layout

Package	SOT 963					
Pins	6					
	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.44	0.48	0.50	0.0173	0.0189	0.0197
B	0.10	0.15	0.20	0.004	0.006	0.008
c	0.05	0.10	0.15	0.002	0.004	0.006
D	0.95	1.00	1.05	0.037	0.039	0.041
E	0.75	0.80	0.85	0.029	0.031	0.033
E1	0.95	1.00	1.05	0.037	0.039	0.041
e	0.35 BSC			0.014 BSC		
L	0.05	0.10	0.15	0.002	0.004	0.006
L1	0.125	0.15	0.175	0.005	0.006	0.007
∅	3°	5°	7°	3°	5°	7°

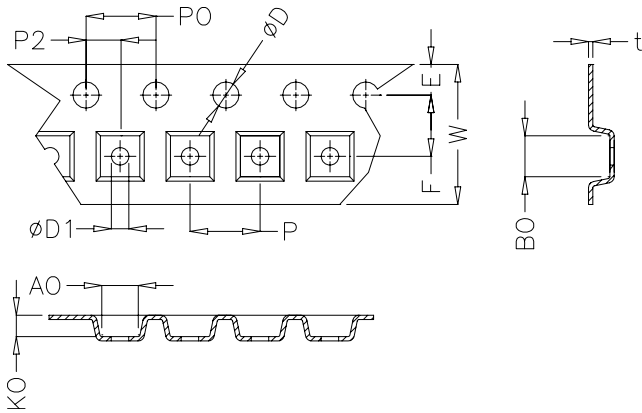
**Embossed Carrier Tape & Reel Specification – SC70-3**



**Dimensions**

Symbol	Millimetres		Inches	
	Min	Max	Min	Max
<b>E</b>	1.65	1.85	0.065	0.073
<b>F</b>	3.45	3.55	0.135	0.139
<b>P2</b>	1.95	2.05	0.077	0.081
<b>D</b>	1.40	1.60	0.055	0.063
<b>D1</b>	1.00	1.25	0.039	0.049
<b>P0</b>	3.90	4.10	0.154	0.161
<b>10P0</b>	40.0 +/- 0.20		1.574 +/- 0.008	
<b>W</b>	7.70	8.10	0.303	0.318
<b>P</b>	3.90	4.10	0.153	0.161
<b>A0</b>	2.30	2.50	0.090	0.098
<b>A1</b>	1.00 Ref		0.039 Ref	
<b>B0</b>	2.30	2.50	0.090	0.098
<b>B1</b>	1.90 Ref		0.074	
<b>K0</b>	1.10	1.30	0.043	0.051
<b>K1</b>	0.60 Ref		0.023 Ref	
<b>t</b>	0.27 max		0.010	

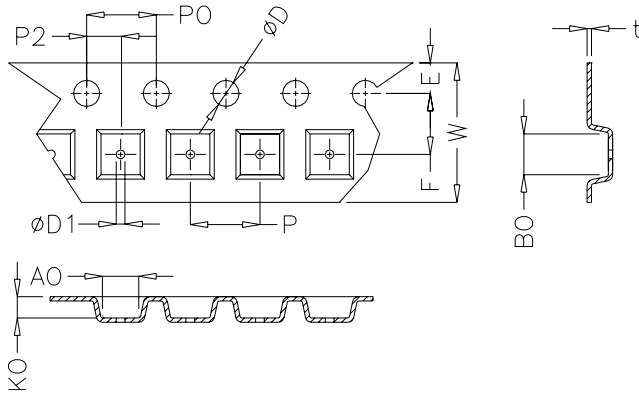
**Embossed Carrier Tape & Reel Specification – SC70-5 and SC70-6**



**Dimensions**

Symbol	Millimetres		Inches	
	Min	Max	Min	Max
<b>E</b>	1.65	1.85	0.065	0.073
<b>F</b>	3.45	3.55	0.135	0.139
<b>P2</b>	1.95	2.05	0.077	0.081
<b>D</b>	1.40	1.60	0.055	0.063
<b>D1</b>	1.00	1.25	0.039	0.049
<b>P0</b>	3.90	4.10	0.154	0.161
<b>10P0</b>	40.0 +/- 0.20		1.574 +/- 0.008	
<b>W</b>	7.70	8.10	0.303	0.318
<b>P</b>	3.90	4.10	0.153	0.161
<b>A0</b>	2.14	2.34	0.084	0.092
<b>B0</b>	2.24	2.44	0.088	0.096
<b>K0</b>	1.12	1.32	0.044	0.052
<b>t</b>	0.27 max		0.010 max	

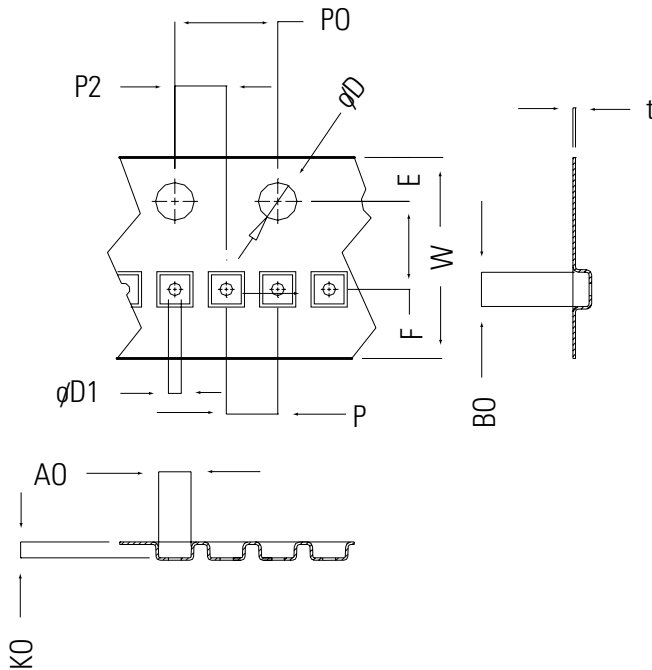
**Embossed Carrier Tape & Reel Specification – SOT553 and SOT563**



**Dimensions**

Symbol	Millimetres		Inches	
	Min	Max	Min	Max
<b>E</b>	1.65	1.85	0.065	0.073
<b>F</b>	3.45	3.55	0.135	0.139
<b>P2</b>	1.95	2.05	0.077	0.081
<b>D</b>	1.40	1.60	0.055	0.063
<b>D1</b>	0.45	0.55	0.017	0.021
<b>P0</b>	3.90	4.1	0.154	0.161
<b>10P0</b>	40.0 +/- 0.20		1574 +/- 0.008	
<b>W</b>	7.70	8.10	0.303	0.318
<b>P</b>	3.90	4.10	0.153	0.161
<b>A0</b>	1.73	1.83	0.068	0.072
<b>B0</b>	1.73	1.83	0.068	0.072
<b>K0</b>	0.64	0.74	0.025	0.029
<b>t</b>	0.22 max		.009 max	

**Embossed Carrier Tape & Reel Specification – SOT963**



**Dimensions**

Symbol	Millimetres		Inches	
	Min	Max	Min	Max
<b>E</b>	1.65	1.85	0.065	0.073
<b>F</b>	3.45	3.55	0.136	0.140
<b>D1</b>	0.45	0.55	0.018	0.022
<b>D</b>	1.50 min		0.059 min	
<b>P0</b>	3.90	4.10	0.154	0.161
<b>10P0</b>	40.0 +/- 0.20		1575 +/- 0.008	
<b>P</b>	1.95	2.05	0.077	0.081
<b>P2</b>	1.95	2.05	0.077	0.081
<b>W</b>	7.90	8.20	0.311	0.323
<b>A0</b>	1.11	1.21	0.044	0.048
<b>B0</b>	1.11	1.21	0.044	0.048
<b>K0</b>	0.58	0.68	0.023	0.027
<b>t</b>	0.22 max		0.009 max	

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